

TVS Diode

Primary characteristics			
Parameter	Symbol	Value	Unit
Peak Pulse Current	I _{PP}	20	A
ESD per IEC 61000-4-2 (Air/Contact)	V _{ESD}	30	kV
Peak Pulse Power	P _{PP}	350	W

Features

- Bidirectional and unidirectional configurations
- Solid-state silicon-avalanche technology
- Low clamping voltage
- Low leakage current
- Molding compound flammability rating: UL 94V-0
- RoHS/WEEE Compliant

Applications

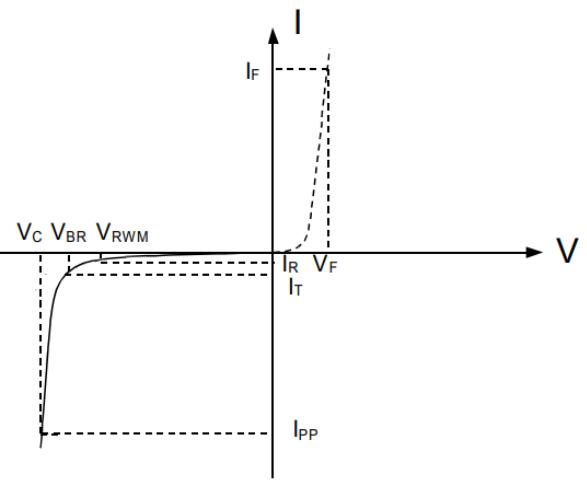
- Automatic Teller Machines
- Networks
- Powerline
- Dataline

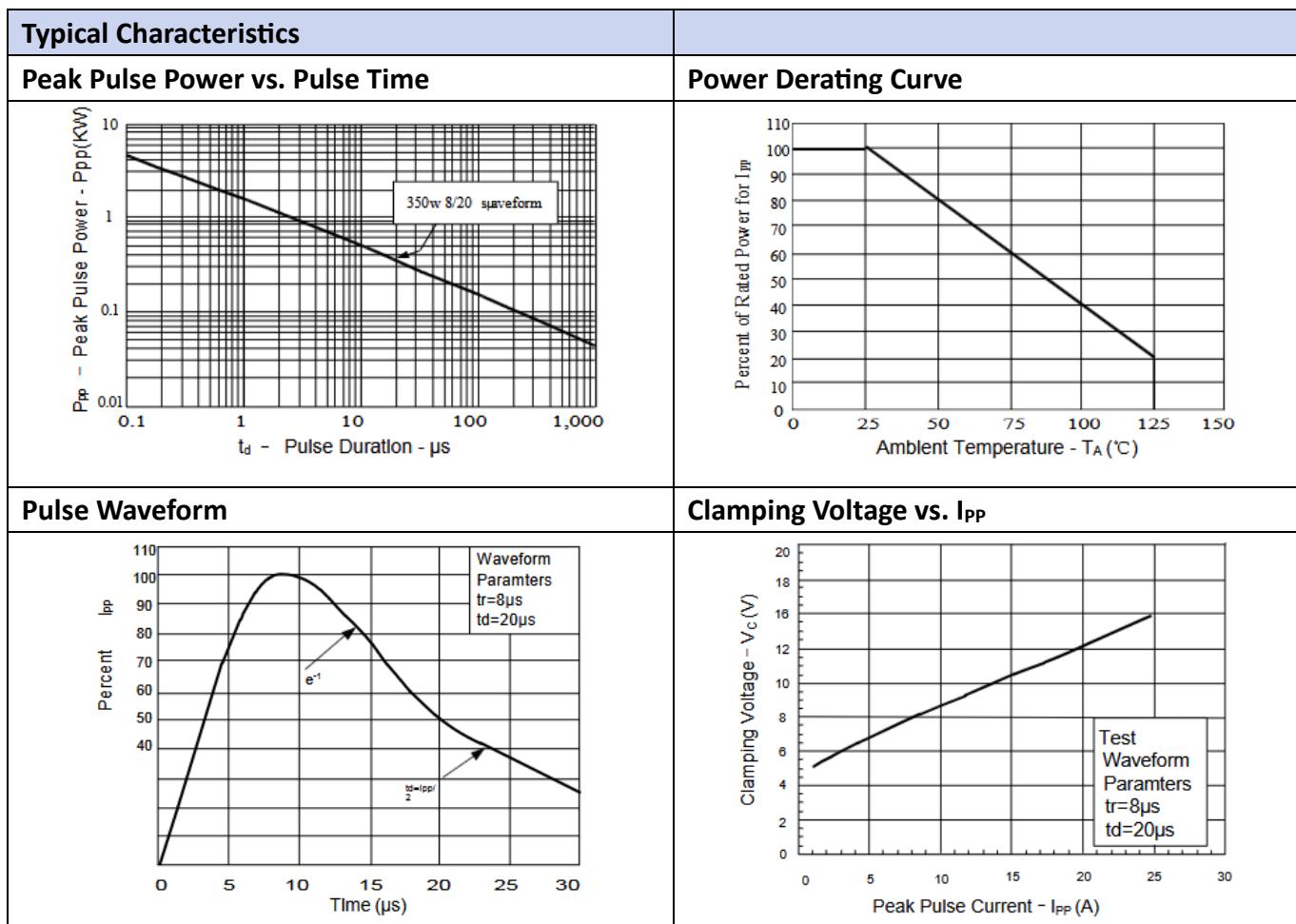
Case dimensions											
SOT-23											
Symbol		A	A1	A2	D	b	E	E1	e	L	θ
Millimeters	Min.	0.900	0.000	0.900	2.800	0.300	2.250	1.200	0.950	0.300	0°
Inches	Max.	1.150	0.100	1.050	3.000	0.500	2.550	1.400	BSC	0.500	8°
	Min.	0.035	0.000	0.035	0.110	0.012	0.089	0.047	0.037	0.012	0°
	Max.	0.045	0.004	0.041	0.118	0.020	0.100	0.055	BSC	0.020	8°

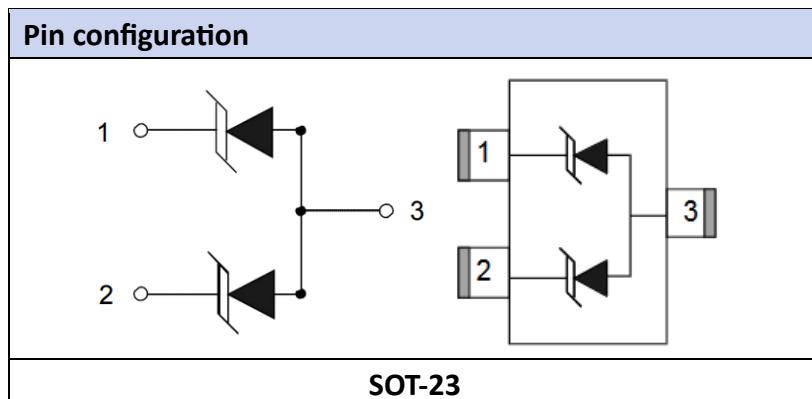
Absolute Maximum Ratings and Electrical Characteristics

Characteristic	Test Conditions	Symbol	Value			Unit
			Min.	Typ.	Max.	
Peak Pulse Power	t _p =8/20μs	P _{PP}	-	350	-	W
Peak Pulse Current	t _p =8/20μs	I _{PP}	-	20	-	A
ESD per IEC 61000-4-2 (Air) ESD per IEC 61000-4-2 (Contact)	-	V _{ESD}	-	30 30	-	kV
Lead Soldering Temperature	-	T _L	-	260	-	°C
Junction Temperature	-	T _J	-55 / +125			°C
Storage Temperature	-	T _{stg}	-55 / +125			°C
Reverse Stand-Off Voltage	-	V _{RWM}	-	-	3.3	V
Reverse Breakdown Voltage	I _T =1mA	V _{BR}	4.0	6.5	8.0	V
Reverse Leakage Current	V _{RWM} =3V, T=25°C	I _R	-	0.1	0.5	μA
Clamping Voltage	I _{pp} =20A, t _p =8/20μs	V _C	-	-	16	V
Junction Capacitance	V _R = 0V, f = 1MHz	C _J	-	200	-	pF

Electrical Parameters ($T_A=25^\circ\text{C}$ unless otherwise noted)

Parameter	Symbol	
Maximum Reverse Peak Pulse Current	I_{PP}	
Clamping Voltage @ I_{PP}	V_C	
Working Peak Reverse Voltage	V_{RWM}	
Maximum Reverse Leakage Current @ V_{RWM}	I_R	
Breakdown Voltage @ I_T	V_{BR}	
Test Current	I_T	





Ordering information			
Part Number	Package	Shipping Quantity	Delivery Mode
PESD3V3S2UT	SOT-23	3 000 pcs	Tape and reel

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